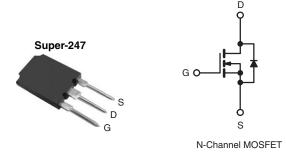
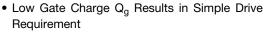


Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V 0.110				
Q _g (Max.) (nC)	330				
Q _{gs} (nC)	84				
Q _{gd} (nC)	150				
Configuration	Single				



FEATURES





• Improved Gate, Avalanche and Dynamic dV/dt Ruggedness

- Fully Characterized Capacitance and Avalanche Voltage
- and Current
- Enhanced Body Diode dV/dt Capability
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Hard Switching Primary or PFC Switch
- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching
- Motor Drive

ORDERING INFORMATION			
Package	Super-247		
Lead (Pb)-free	IRFPS40N60KPbF		
Leau (Fb)-liee	SiHFPS40N60K-E3		
SnPb	IRFPS40N60K		
SILL	SiHFPS40N60K		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	600	V	
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current	\/ at 10 \/	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		40		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	24	Α	
Pulsed Drain Current ^a			I _{DM}	160		
Linear Derating Factor				4.5	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	600	mJ	
Repetitive Avalanche Current ^a			I _{AR}	40	Α	
Repetitive Avalanche Energy ^a			E _{AR}	57	mJ	
Maximum Power Dissipation T _C = 25 °C			P_{D}	570	W	
Peak Diode Recovery dV/dt ^c			dV/dt	7.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	- °C	
Soldering Recommendations (Peak Temperature) for 10 s				300 ^d	1	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting T_J = 25 °C, L = 0.84 mH, R_g = 25 Ω , I_{AS} = 38 A, dV/dt = 5.5 V/ns (see fig. 12a). c. I_{SD} ≤ 38 A, dI/dt ≤ 150 A/µs, V_{DD} ≤ V_{DS}, T_J ≤ 150 °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRFPS40N60K, SiHFPS40N60K

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	40		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24	-	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.22		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							<u> </u>
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	600	-	<u> </u>	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referen	ce to 25 °C, I _D = 1 mA	-	0.63	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS}	= V _{GS} , I _D = 250 μA	3.0	-	5.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 100	nA
7 0	_	V _{DS} = 600 V, V _{GS} = 0 V		-	-	50	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 \	V, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 24 A ^b	-	0.110	0.130	Ω
Forward Transconductance	9 _{fs}	V_{DS}	= 50 V, I _D = 24 A ^b	21	-	-	S
Dynamic					•	•	
Input Capacitance	C _{iss}		$V_{GS} = 0 \text{ V},$	-	7970	-	
Output Capacitance	Coss	1	$V_{DS} = 25 \text{ V},$	-	750	-	i l
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	75	-	
Outrat Considers	0		V _{DS} = 1.0 V , f = 1.0 MHz	-	9440	-	pF
Output Capacitance	C_{oss}	$V_{GS} = 0 V$	V _{DS} = 480 V , f = 1.0 MHz	-	200	-	
Effective Output Capacitance	Coss eff.		V _{DS} = 0 V to 480 V ^c		260	-	
Total Gate Charge	Qg				-	330	
Gate-Source Charge	Q _{gs}	7	$I_D = 38 \text{ A}, V_{DS} = 480 \text{ V},$ see fig. 6 and 13^b	-	-	84	nC
Gate-Drain Charge	Q _{gd}	7	occ lig. c and re	-	-	150	
Turn-On Delay Time	t _{d(on)}	V _{GS} = 10 V		-	47	-	200
Rise Time	t _r		$V_{DD} = 300 \text{ V}, I_D = 38 \text{ A},$	-	110	-	
Turn-Off Delay Time	t _{d(off)}		$R_G = 4.3 \Omega$, see fig. 10 ^b		97	-	ns
Fall Time	t _f	1		-	60	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	40	_
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	160	- A
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 38 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$		-	-	1.5	V
Dady Diada Dayersa Dagger Time	t _{rr}	T _J = 25 °C	I _F = 38 A, dl/dt = 100 A/μs	-	630	950	
Body Diode Reverse Recovery Time		T _J = 125 °C		-	730	1090	ns
Rady Diada Dayaraa Dagayary Charry	Q _{rr} -	T _J = 25 °C		-	14	20	
Body Diode Reverse Recovery Charge		T _J = 125 °C		-	17	25	μC
Body Diode Recovery Current	I _{RRM}		-	39	58	Α	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)					I ^D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s$; duty cycle $\leq 2~\%$.
- c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

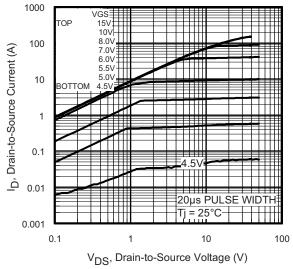


Fig. 1 - Typical Output Characteristics

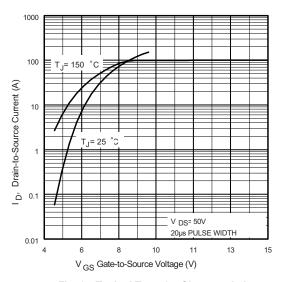


Fig. 3 - Typical Transfer Characteristics

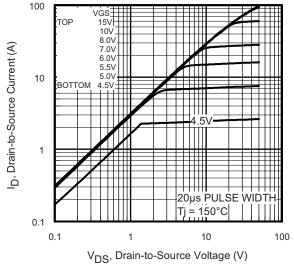


Fig. 2 - Typical Output Characteristics

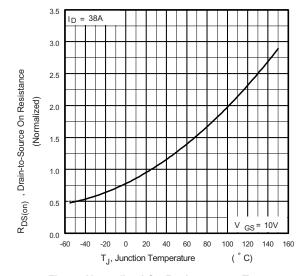


Fig. 4 - Normalized On-Resistance vs. Temperature



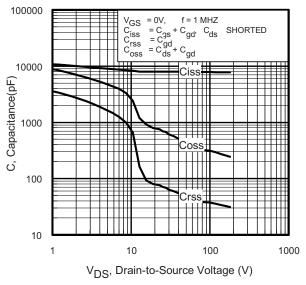


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

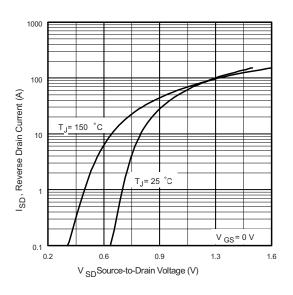


Fig. 7 - Typical Source-Drain Diode Forward Voltage

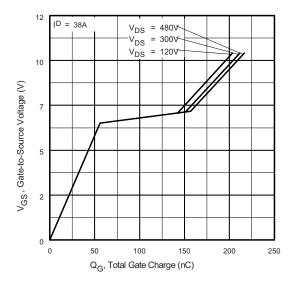


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

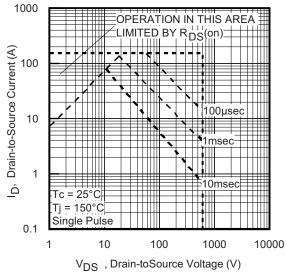


Fig. 8 - Maximum Safe Operating Area

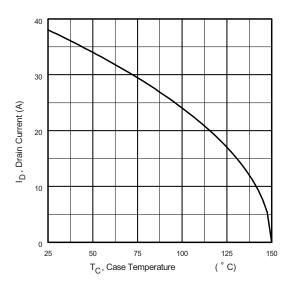


Fig. 9 - Maximum Drain Current vs. Case Temperature

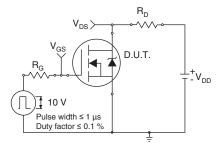


Fig. 10a - Switching Time Test Circuit

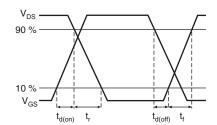


Fig. 10b - Switching Time Waveforms

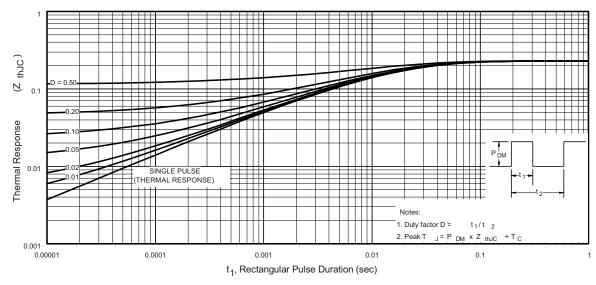


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



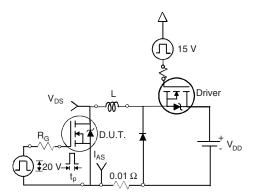


Fig. 12a - Unclamped Inductive Test Circuit

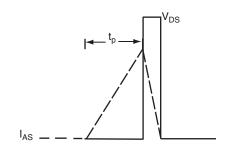


Fig. 12b - Unclamped Inductive Waveforms

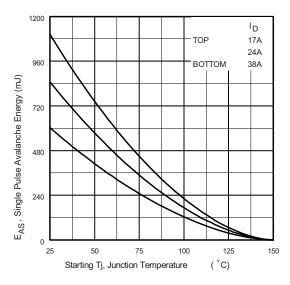


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

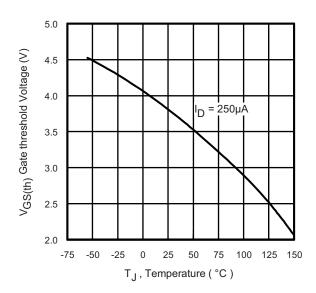


Fig. 12d - Threshold Voltage vs. Temperature

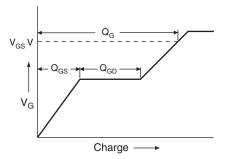


Fig. 13a - Basic Gate Charge Waveform

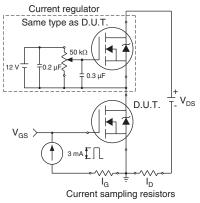
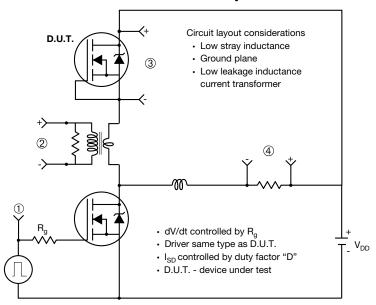


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



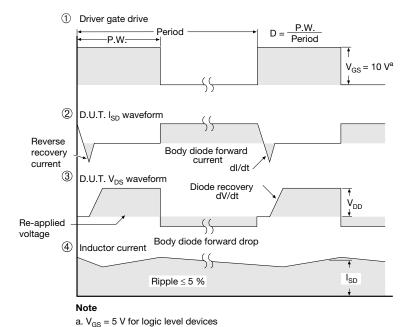


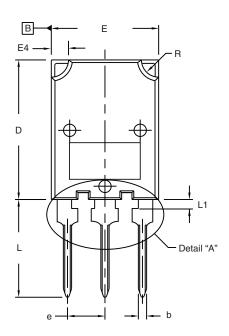
Fig. 14 - For N-Channel

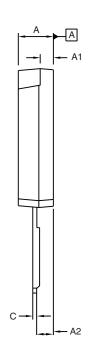
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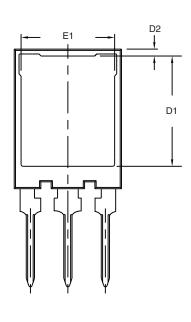
Document Number: 91261 S11-0112-Rev. B, 31-Jan-11

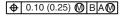


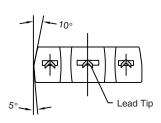
TO-274AA (High Voltage)

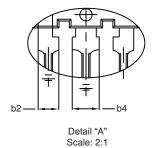












	MILLIMETERS		METERS INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.70	5.30	0.185	0.209
A1	1.50	2.50	0.059	0.098
A2	2.25	2.65	0.089	0.104
b	1.30	1.60	0.051	0.063
b2	1.80	2.20	0.071	0.087
b4	3.00	3.25	0.118	0.128
c ⁽¹⁾	0.38	0.89	0.015	0.035
D	19.80	20.80	0.780	0.819

	MILLIMETERS		RS INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
D1	15.50	16.10	0.610	0.634
D2	0.70	1.30	0.028	0.051
Е	15.10	16.10	0.594	0.634
E1	13.30	13.90	0.524	0.547
е	5.45 BSC		0.215 BSC	
L	13.70	14.70	0.539	0.579
L1	1.00	1.60	0.039	0.063
R	2.00	3.00	0.079	0.118

ECN: X17-0056-Rev. B, 27-Mar-17

DWG: 5975

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outer extremes of the plastic body
- Outline conforms to JEDEC® outline to TO-274AA
- (1) Dimension measured at tip of lead



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